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April 1st, 2010 Renesas Electronics Corporation

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DATA SHEET



MOS FIELD EFFECT TRANSISTOR $\mu PA1760$

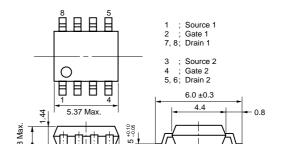
SWITCHING N-CHANNEL POWER MOS FET INDUSTRIAL USE

DESCRIPTION

The μ PA1760 is N-Channel MOS Field Effect Transistor designed for DC/DC Converters and power management application of notebook computers.

FEATURES

- Dual Chip Type
- Low On-Resistance $R_{DS(on)1} = 26.0 \text{ m}\Omega \text{ MAX.}$ (VGs = 10 V, ID = 4.0 A) $R_{DS(on)2} = 36.0 \text{ m}\Omega \text{ MAX.}$ (VGs = 4.5 V, ID = 4.0 A) $R_{DS(on)3} = 42.0 \text{ m}\Omega \text{ MAX.}$ (VGs = 4.0 V, ID = 4.0 A)
- Low Ciss : Ciss = 760 pF TYP.
- Built-in G-S Protection Diode
- Small and Surface Mount Package (Power SOP8)



 0.5 ± 0.2

□ 0.10

PACKAGE DRAWING (Unit : mm)

1.27 0.78 Max

0.40 ^{+0.10} \oplus 0.12 M

0.051

ABSOLUTE MAXIMUM RATINGS (TA = 25°C, All terminals are connected.)

Drain to Source Voltage (Vgs = 0 V)	VDSS	30	V	
Gate to Source Voltage (VDS = 0 V)	Vgss	±20	V	EQUIVALENT CIRCUIT
Drain Current (DC)	D(DC)	±8.0	А	(1/2 Circuit)
Drain Current (Pulse) ^{Note1}	D(pulse)	±32	А	
Total Power Dissipation (1 unit) Note2	Рт	1.7	W	Drain
Total Power Dissipation (2 unit) Note2	Рт	2.0	W	•
Channel Temperature	Tch	150	°C	Body
Storage Temperature	Tstg	–55 to + 150	°C	
Single Avalanche Current Note3	las	8	А	Gate
Single Avalanche Energy Note3	Eas	6.4	mJ	Protection Source Diode

Notes 1. PW \leq 10 μ s, Duty cycle \leq 1%

- **2.** $T_A = 25^{\circ}C$, Mounted on ceramic substrate of 2000 mm² x 1.6 mm
- 3. Starting T_{ch} = 25°C, R_G = 25 Ω , V_{GS} = 20 V \rightarrow 0 V
- RemarkThe diode connected between the gate and source of the transistor serves as a protector against ESD.When this device actually used, an additional protection circuit is externally required if a voltageExceeding the rated voltage may be applied to this device.

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The mark \star shows major revised points.

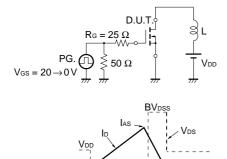
CHARACTERISTICS	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Drain to Source On-state Resistance	RDS(on)1	Vgs = 10 V, Id = 4.0 A		20.5	26.0	mΩ
	RDS(on)2	Vgs = 4.5 V, Id = 4.0 A		27.0	36.0	mΩ
	RDS(on)3	Vgs = 4.0 V, Id = 4.0 A		31.0	42.0	mΩ
Gate to Source Cut-off Voltage	V _{GS(off)}	V _{DS} = 10 V, I _D = 1 mA	1.5	2.1	2.5	V
Forward Transfer Admittance	yfs	Vds = 10 V, Id = 4.0 A	3.0	7.5		S
Drain Leakage Current	IDSS	Vds = 30 V, Vgs = 0 V			10	μA
Gate to Source Leakage Current	lgss	$V_{GS} = \pm 16 \text{ V}, \text{ V}_{DS} = 0 \text{ V}$			±10	μA
Input Capacitance	Ciss	V _{DS} = 10 V		760		pF
Output Capacitance	Coss	Vgs = 0 V		250		pF
Reverse Transfer Capacitance	Crss	f = 1 MHz		95		pF
Turn-on Delay Time	td(on)	ID = 4.0 A		20		ns
Rise Time	tr	VGS(on) = 10 V		140		ns
Turn-off Delay Time	td(off)	Vdd = 15 V		50		ns
Fall Time	tr	R _G = 10 Ω		30		ns
Total Gate Charge	QG	ID = 8.0 A		14		nC
Gate to Source Charge	Q _{GS}	V _{DD} = 24 V		2.0		nC
Gate to Drain Charge	Qgd	Vgs = 10 V		5.0		nC
Body Diode Forward Voltage	VF(S-D)	IF = 8.0 A, VGS = 0 V		0.86		V
Reverse Recovery Time	trr	IF = 8.0 A, VGS = 0 V		30		ns
Reverse Recovery Charge	Qrr	di/dt = 100A/µs		20		nC

ELECTRICAL CHARACTERISTICS (TA = 25°C, All terminals are connected.)

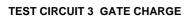
TEST CIRCUIT 1 AVALANCHE CAPABILITY

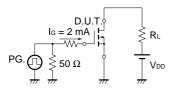
TEST CIRCUIT 2 SWITCHING TIME

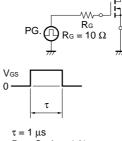
D.U.T



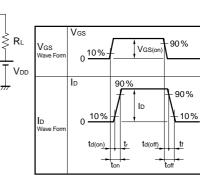
Starting Tch





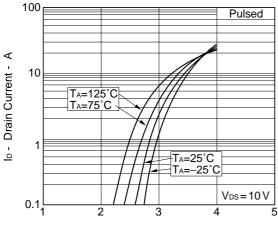


Duty Cycle $\leq 1 \%$



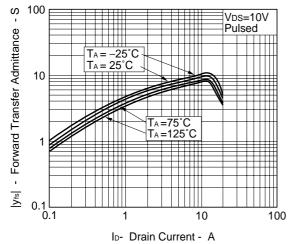


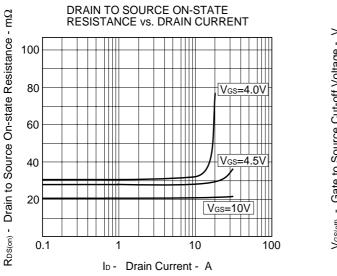
FORWARD TRANSFER CHARACTERISTICS

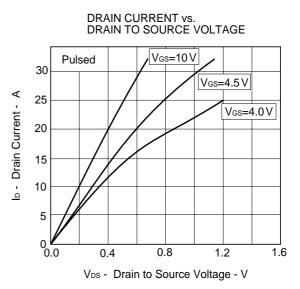


Vgs - Gate to Source Voltage - V

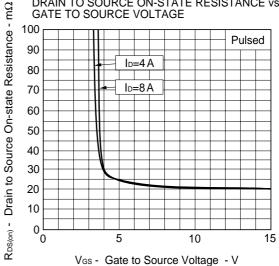




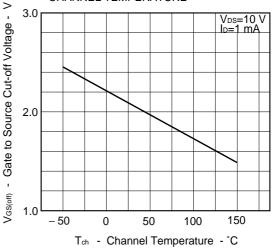




DRAIN TO SOURCE ON-STATE RESISTANCE vs. GATE TO SOURCE VOLTAGE

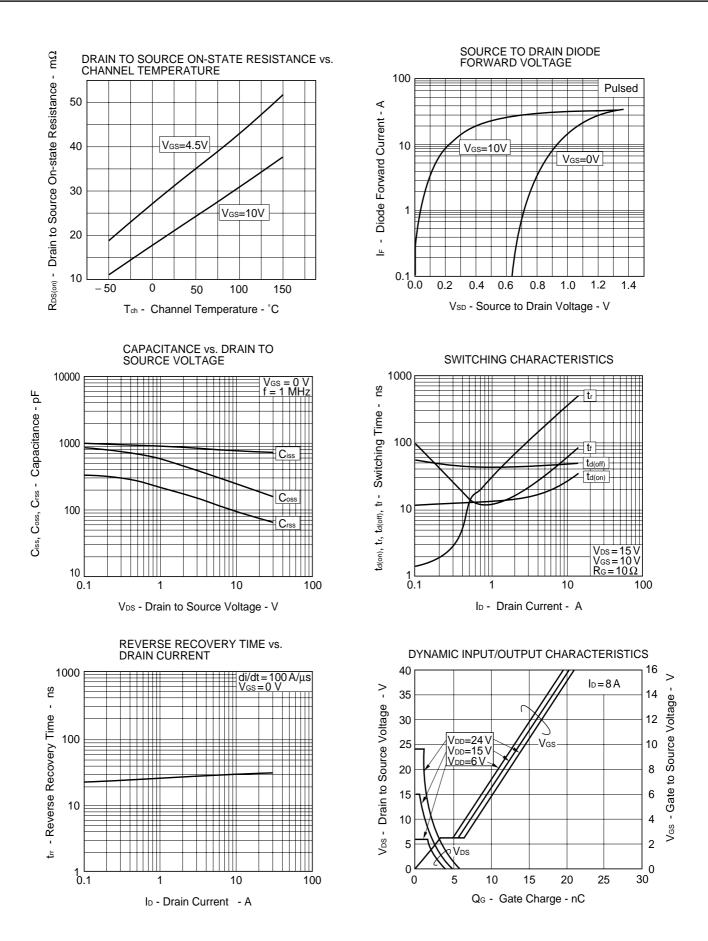


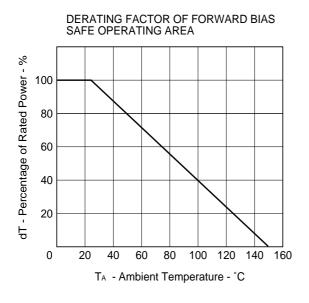
GATE TO SOURCE CUT-OFF VOLTAGE vs. CHANNEL TEMPERATURE



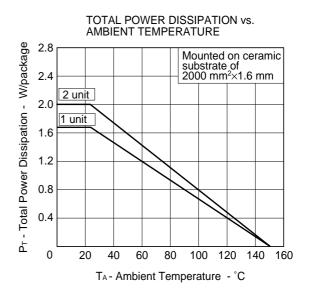
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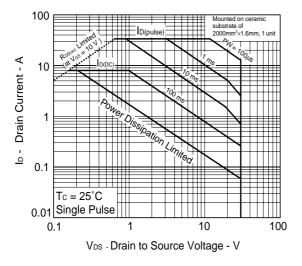


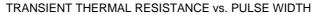


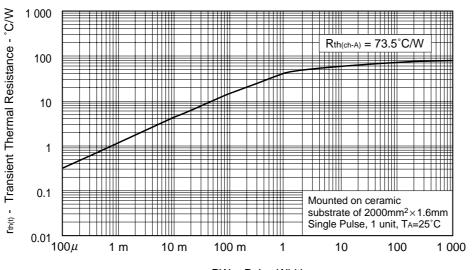
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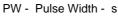


★ FORWARD BIAS SAFE OPERATING AREA

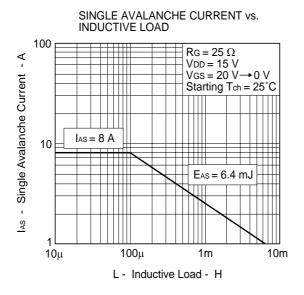


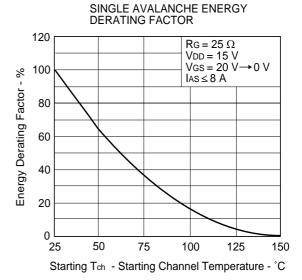






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